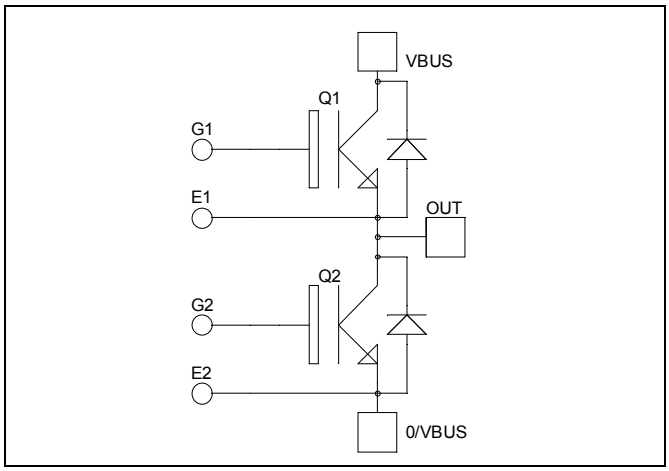
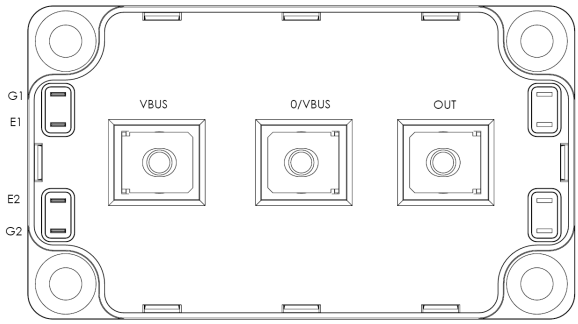
APTGT600A60G

Phase leg
Trench + Field Stop IGBT3
Power Module

V_{CES} = 600V
I_C = 600A* @ Tc = 80°C





Application

- Welding converters
- Switched Mode Power Supplies
- Uninterruptible Power Supplies
- Motor control

Features

- Trench + Field Stop IGBT3 Technology
  - Low voltage drop
  - Low tail current
  - Switching frequency up to 20 kHz
  - Soft recovery parallel diodes
  - Low diode VF
  - Low leakage current
  - RBSOA and SCSOA rated
- Kelvin emitter for easy drive
- Very low stray inductance
  - Symmetrical design
  - M5 power connectors
- High level of integration

Benefits

- Stable temperature behavior
- Very rugged
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Easy paralleling due to positive T_C of V_{CEsat}
- Low profile
- RoHS Compliant

Absolute maximum ratings

Symbol	*Parameter*		*Max ratings*	*Unit*
V_{CES}	Collector - Emitter Breakdown Voltage		600	V
I_C	Continuous Collector Current	T_C = 25°C	700 *	A
		T_C = 80°C	600 *	
I_{CM}	Pulsed Collector Current	T_C = 25°C	800	
V_{GE}	Gate – Emitter Voltage		±20	V
P_D	Maximum Power Dissipation	T_C = 25°C	2300	W
RBSOA	Reverse Bias Safe Operating Area	T_j = 150°C	1200A @ 550V	

* Specification of IGBT device but output current must be limited to 500A to not exceed a delta of temperature greater than 100°C for the connectors.

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

All ratings @ T_j = 25°C unless otherwise specified

Electrical Characteristics

Symbol	*Characteristic*	*Test Conditions*		*Min*	*Typ*	*Max*	*Unit*
I_{CES}	Zero Gate Voltage Collector Current	V_{GE} = 0V, V_{CE} = 600V				750	µA
$V_{CE(sat)}$	Collector Emitter Saturation Voltage	V_{GE} =15V I_C = 600A	T_j = 25°C		1.4	1.8	V
			T_j = 150°C		1.5		
$V_{GE(th)}$	Gate Threshold Voltage	V_{GE} = V_{CE} , I_C = 2mA		5.0	5.8	6.5	V
I_{GES}	Gate – Emitter Leakage Current	V_{GE} = 20V, V_{CE} = 0V				800	nA

Dynamic Characteristics

Symbol	*Characteristic*	*Test Conditions*		*Min*	*Typ*	*Max*	*Unit*
C_{ies}	Input Capacitance	V_{GE} = 0V V_{CE} = 25V f = 1MHz			49		nF
C_{oes}	Output Capacitance				3.1		
C_{res}	Reverse Transfer Capacitance				1.5		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (25°C) V_{GE} = ±15V V_{Bus} = 300V I_C = 600A R_G = 1Ω			130		ns
T_r	Rise Time				55		
$T_{d(off)}$	Turn-off Delay Time				250		
T_f	Fall Time				60		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (150°C) V_{GE} = ±15V V_{Bus} = 300V I_C = 600A R_G = 1Ω			145		ns
T_r	Rise Time				60		
$T_{d(off)}$	Turn-off Delay Time				320		
T_f	Fall Time				80		
E_{on}	Turn on Energy	V_{GE} = ±15V V_{Bus} = 300V I_C = 600A R_G = 1Ω	T_j = 25°C		3		mJ
			T_j = 150°C		5.5		
E_{off}	Turn off Energy		T_j = 25°C		17		mJ
			T_j = 150°C		21		

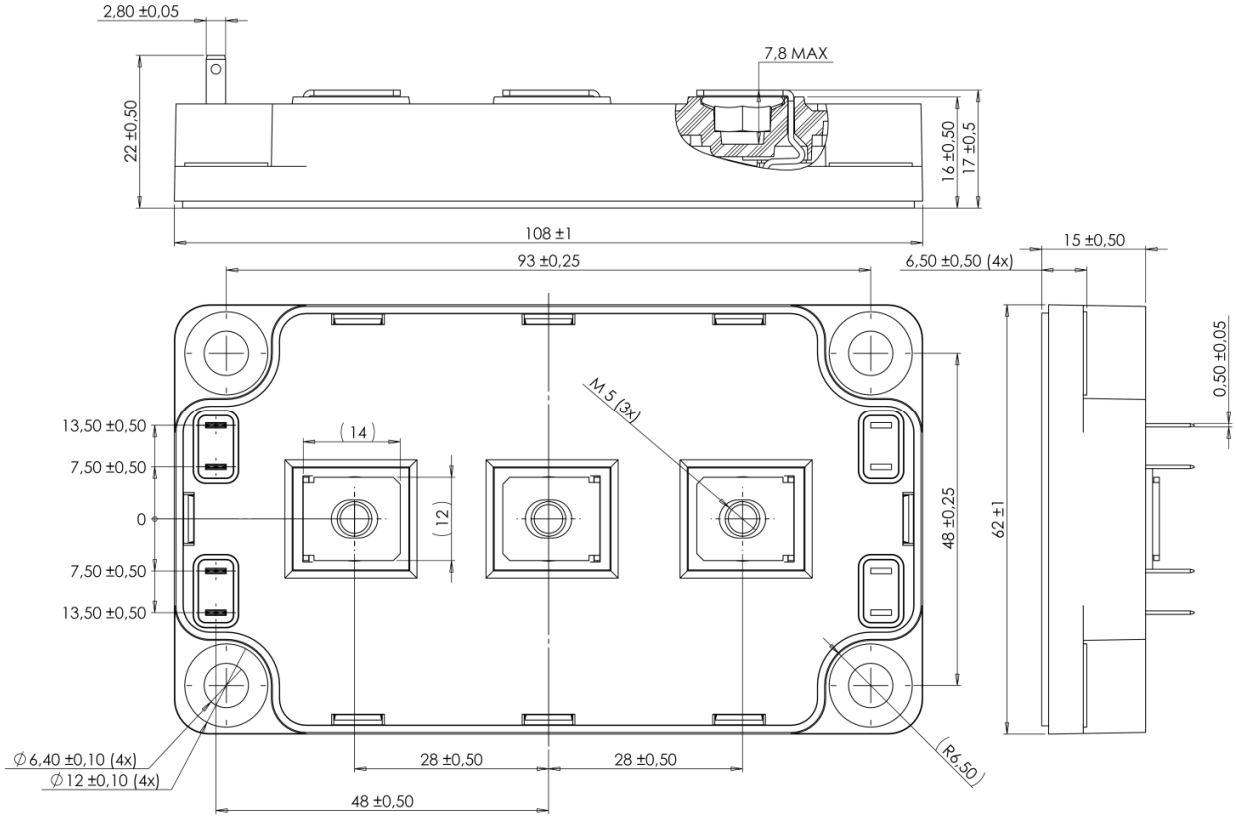
Reverse diode ratings and characteristics

Symbol	*Characteristic*	*Test Conditions*		*Min*	*Typ*	*Max*	*Unit*
V_{RRM}	Maximum Peak Repetitive Reverse Voltage			600			V
I_{RM}	Maximum Reverse Leakage Current	V_R=600V	T_j = 25°C			350	µA
			T_j = 150°C			550	
I_F	DC Forward Current		Tc = 80°C		600		A
V_F	Diode Forward Voltage	I_F = 600A V_{GE} = 0V	T_j = 25°C		1.5	1.9	V
			T_j = 150°C		1.4		
t_{rr}	Reverse Recovery Time	I_F = 600A V_R = 300V di/dt =5000A/µs	T_j = 25°C		120		ns
			T_j = 150°C		210		
Q_{rr}	Reverse Recovery Charge		T_j = 25°C		27		µC
			T_j = 150°C		57		
E_r	Reverse Recovery Energy		T_j = 25°C		6.9		mJ
			T_j = 150°C		14.1		

Thermal and package characteristics

Symbol	*Characteristic*			*Min*	*Typ*	*Max*	*Unit*
R_{thJC}	Junction to Case Thermal Resistance		IGBT			0.065	°C/W
			Diode			0.11	
V_{ISOL}	RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz			4000			V
T_J	Operating junction temperature range			-40		175	°C
T_{STG}	Storage Temperature Range			-40		125	
T_C	Operating Case Temperature			-40		100	
Torque	Mounting torque	To heatsink	M6	3		5	N.m
		For terminals	M5	2		3.5	
Wt	Package Weight					300	g

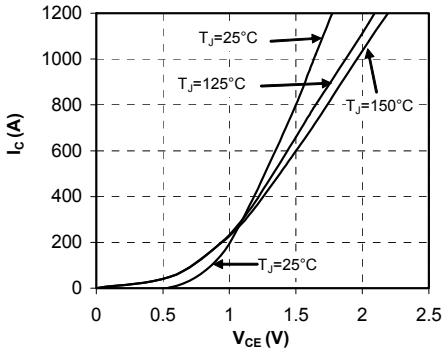
SP6 Package outline (dimensions in mm)



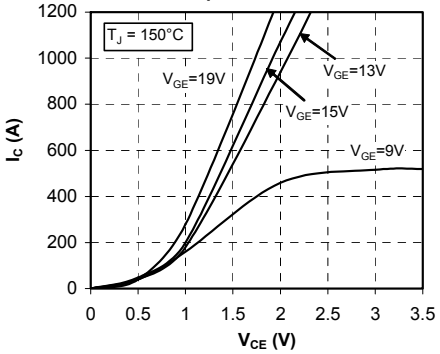
See application note APT0601 - Mounting Instructions for SP6 Power Modules on www.microsemi.com

Typical Performance Curve

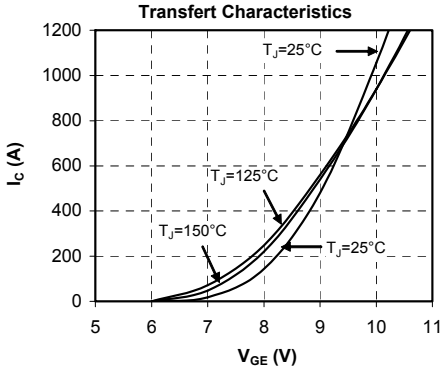
Output Characteristics (V_{GE}=15V)



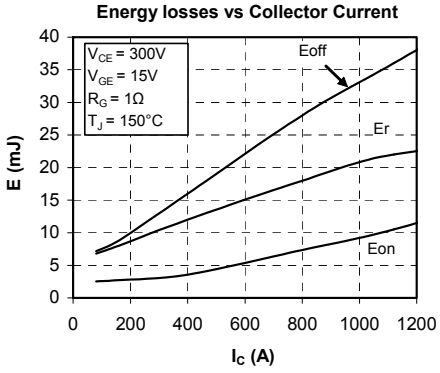
Output Characteristics



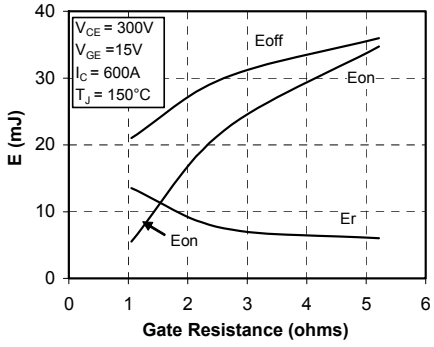
Transfert Characteristics



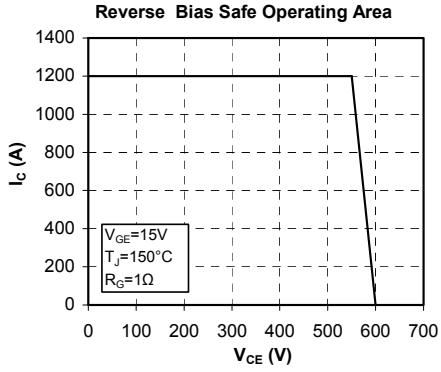
Energy losses vs Collector Current



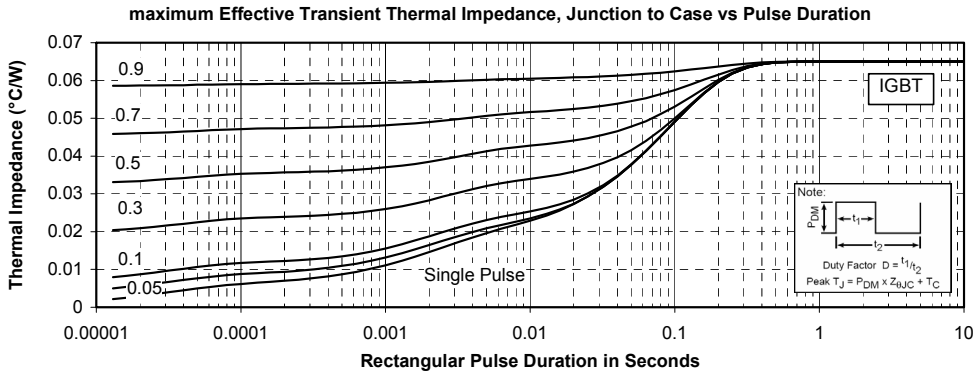
Switching Energy Losses vs Gate Resistance

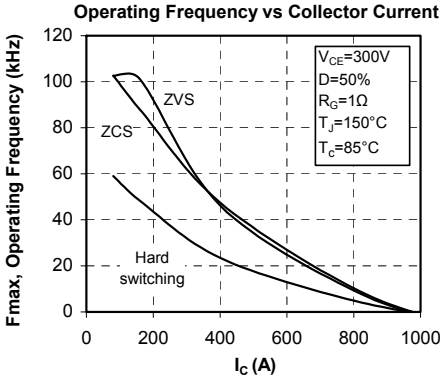


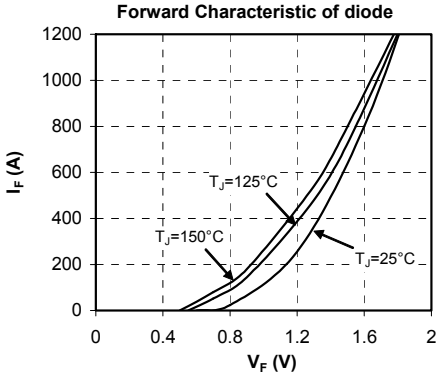
Reverse Bias Safe Operating Area

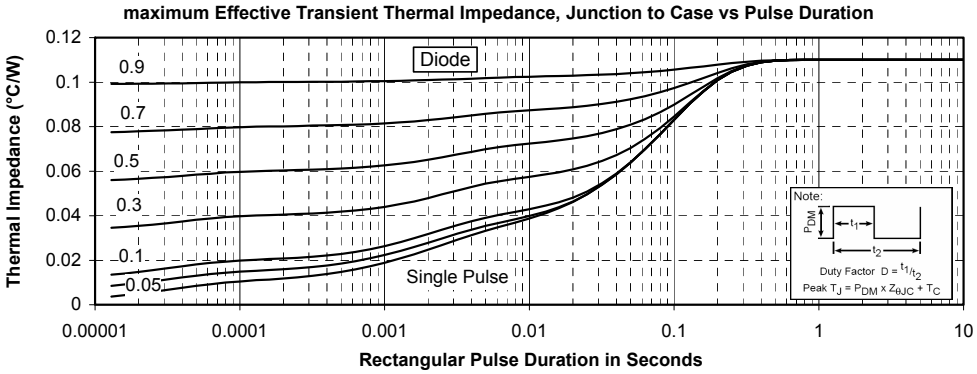


maximum Effective Transient Thermal Impedance, Junction to Case vs Pulse Duration




Operating Frequency vs Collector Current
Fmax, Operating Frequency (kHz)
I_C (A)
V_{CE}=300V
D=50%
R_G=1Ω
T_J=150°C
T_C=85°C
ZVS
ZCS
Hard switching
0
20
40
60
80
100
120
0
200
400
600
800
1000


Forward Characteristic of diode
I_F (A)
V_F (V)
T_J=125°C
T_J=150°C
T_J=25°C
0
200
400
600
800
1000
1200
0
0.4
0.8
1.2
1.6
2


maximum Effective Transient Thermal Impedance, Junction to Case vs Pulse Duration
Thermal Impedance (°C/W)
Rectangular Pulse Duration in Seconds
Diode
Single Pulse
0.9
0.7
0.5
0.3
0.1
0.05
Note:
Duty Factor D = t_1/t_2
Peak T_J = P_{DM} x $Z_{\theta JC}$ + T_C
0
0.02
0.04
0.06
0.08
0.1
0.12
0.00001
0.0001
0.001
0.01
0.1
1
10

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